




SPECIFICATION SHEET NO.	R1018- CR4M200000S039	
ORIGINAL MFG/PART NO	TGS Crystals/CRTR 4.2MG-39 TLH/ZTTTCR 4.2MG-39	
DATE	Oct. 18, 2024	
REVISION	A2	Updated With Most Recent Data
DESCRIPTION AND MAIN PARAMETRICS	MHz SMD Ceramic Resonator, 3 Pads, CR Series Case 4520, Dimension L4.5*W2.0*H1.2mm 4.20MHz, Frequency Accuracy $\pm 0.5\%$; Built-in Capacitance 39pF Operating Temp. Range -25°C ~+85°C Reflow Profile Condition 260 °C Max. Package in Tape/Reel, 3000pcs/Reel REACH/RoHS/RoHS III Compliant, RoHS Annex III lead Exemption (Exempt per RoHS EU 2015/863)	
CUSTOMER		
CUSTOMER PART NUMBER		
CROSS REF. PART NUMBER		
MEMO		

VENDOR APPROVE			
Issued/Checked/Approved			
Date: Oct. 18, 2024			

CUSTOMER APPROVE
Date:

MAIN FEATURE

- MHz SMD Resonator, 3 pads, Case 4520
- Case Dimension L4.5*W2.0*H1.2mm
- Low Cost And Short Shipment
- Cross More Competitors Part
- Built-in Capacitance
- Reflow Profile Condition 260 °C Max.
- REACH/RoHS/RoHS III compliant, RoHS Annex III lead Exemption
(Exempt per RoHS EU 2015/863)

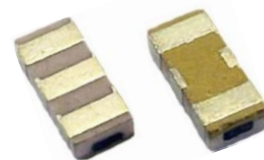


Image shown is a representation only. Exact specifications should be obtained from the product dimension.



APPLICATION

- Communication Electronics
- Bluetooth, wireless communication set

HOW TO ORDER

- Please follow up part code guide and indicate part code when you order or RFQ.

RFQ
[Request For Quotation](#)

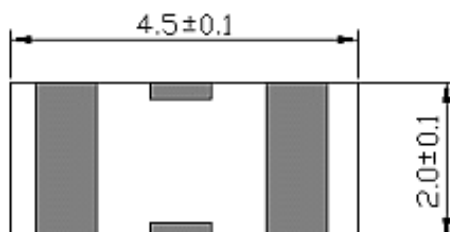
PART CODE GUIDE

CODE	NAME	KEY SPECIFICATION OPTION
CR	Product Series	MHz SMD Resonator, 3 pads, Case 4520 Dimension L4.5*W2.0*H1.2mm
4M2	Frequency Range	4M2: 4.20MHz
00000	Internal Control	Letter or Digits (A~Z, a~z or 1~9)
S	SMD Type Package	Tape/Reel
039	Special Parametric	Letter or Digits (A~Z, a~z or 1~9)
-XX	Suffix	Blank: N/A XX: Internal Control Code, Letter A~Z, a~z or digits (0~9) for Special/Custom Parameters

DIMENSION (Unit: mm)

Case 4520, 3 Pads
L4.5*W2.0*H1.2mm

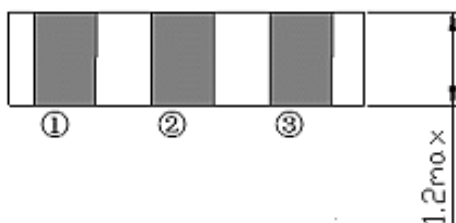
Top View


Marking

Frequency Range

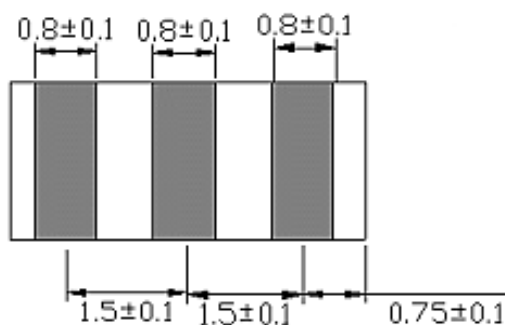
+ QC Code

Side View

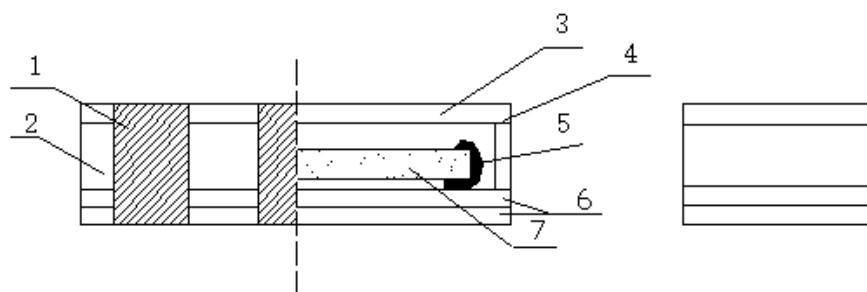


Connection: ① Input ② Ground ③ Output

Side View



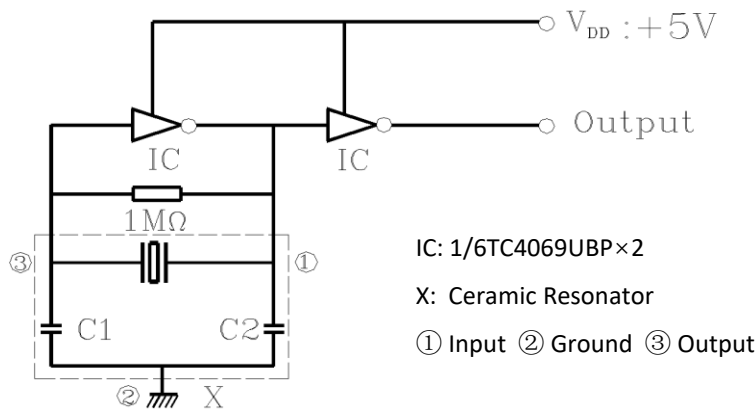
STRUCTURE



NO.	COMPONENTS	MATERIALS
1	Outer Electrodes	Top and Bottom Electrodes Ag + Ni(under plating) + Sn(over plating) Side Electrodes Ni + Cu + Ag(under plating)+Sn(over plating)
2	Ceramic Box	Insulation Box
3	Cover	Dielectric Material
4	Glue	Epoxy Resin
5	Conductive Adhesive	Ag + Epoxy Resin
6	Base	Dielectric Material
7	Ceramic Element	Piezoelectric Ceramics (PZT)

MEASUREMENT

- Parts shall be tested under the condition (Temp.: $20 \pm 15^{\circ}\text{C}$, Humidity $65 \pm 20\%$ R.H.) unless the standard condition (Temp.: $25 \pm 3^{\circ}\text{C}$, Humidity : $65 \pm 10\%$ R.H.) is regulated to measure.
- Measuring Circuit



GENERAL ELECTRICAL CHARACTERISTICS AND RATING- FOR DIFFERENT PART CODE- Ta = 25°C

PARAMETER	SYMBOLS	VALUE	UNITS	CONDITION
Withstanding Voltage	-	50	V	@DC, 1 min.
Insulation Resistance	R i	500 Min.	mΩ	@10V, 1min.
Operating Temperature Range	T J	-25 to +85	°C	
Storage Temperature Range	T STG	-55 to +85	°C	
Rating Voltage	U R	6	V DC	
		15	V p-p	
Temperature Coefficient of Oscillation Frequency		±0.3 Max.	%	Oscillation Frequency drift, -25°C ~ +85°C
Oscillation Frequency Aging Rate (10 Years) *		±0.1 Max.		From initial value

Note: * : Components shall be left in a chamber of $+85 \pm 2^{\circ}\text{C}$ for 1000 hours, then measured after leaving in natural condition for 1 hours.

ELECTRICAL CHARACTERISTICS - FOR DIFFERENT PART CODE

PART CODE	CENTER FREQUENCY (F0)	FREQUENCY ACCURACY	MAX.RESONANT IMPEDANCE R0	BUILT-IN CAPACITANCE C1, C2	IC MODEL NO.
	MHz	%	Ω	pF	
CR4M000000S015	4.00	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR4M000000S039	4.00	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR4M096000S015	4.096	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR4M096000S039	4.096	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR4M190000S015	4.19	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR4M194000S039	4.194	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR4M200000S015	4.20	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR4M200000S039	4.20	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR4M258000S015	4.258	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR4M500000S039	4.50	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR4M910000S015	4.91	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR4M910000S039	4.91	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR5M000000S015	5.00	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR5M000000S039	5.00	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR6M000000S015	6.00	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR6M000000S039	6.00	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR6M250000S033	6.25	±0.5	40	33 (1±20%)	1/6TC4069UBPx2
CR6M250000S039	6.25	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR6M290000S015	6.29	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR6M400000S039	6.40	±0.5	40	39 (1±20%)	1/6TC4069UBPx2

ELECTRICAL CHARACTERISTICS - FOR DIFFERENT PART CODE

PART CODE	CENTER FREQUENCY (F0)	FREQUENCY ACCURACY	MAX.RESONANT IMPEDANCE R0	BUILT-IN CAPACITANCE C1, C2	IC MODEL NO.
	MHz	%	Ω	pF	
CR6M600000S039	6.60	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR6M750000S015	6.75	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR6M750000S039	6.75	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR6M875000S015	6.875	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR7M000000S015	7.00	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR7M000000S033	7.00	±0.5	40	33 (1±20%)	1/6TC4069UBPx2
CR7M000000S039	7.00	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR7M200000S015	7.20	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR7M280000S033	7.28	±0.5	40	33 (1±20%)	1/6TC4069UBPx2
CR7M370000S015	7.37	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CR7M370000S039	7.37	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR7M500000S039	7.50	±0.5	40	39 (1±20%)	1/6TC4069UBPx2
CR7M680000S015	7.68	±0.5	40	15 (1±20%)	1/6TC4069UBPx2

PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

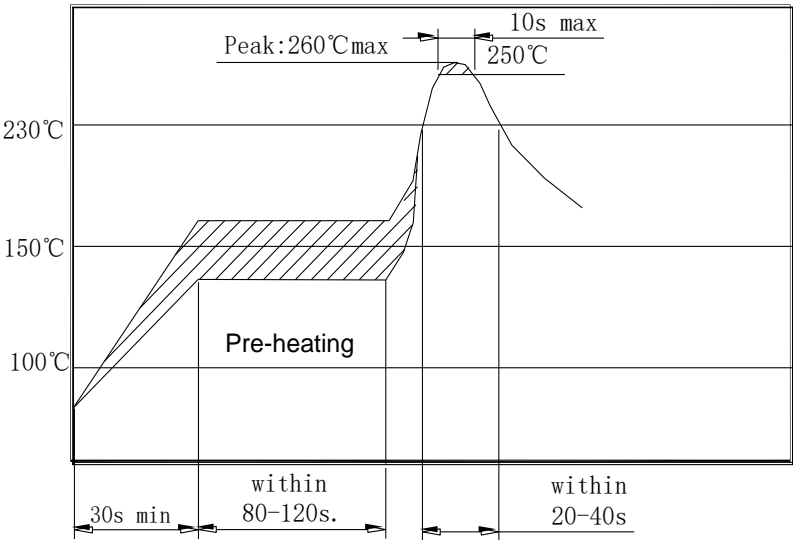
TEST ITEMS	TEST METHOD AND CONDITIONS	REQUIREMENT
Humidity	Keep the resonator at $40^{\circ}\text{C} \pm 2^{\circ}\text{C}$ and 90%-95% RH for 96h. Then Release the resonator into the room Condition for 1h prior to the Measurement.	It shall fulfill the specifications in Table 1
High Temperature	Subject the resonator to $85^{\circ}\text{C} \pm 2^{\circ}\text{C}$ for 96h, then release the resonator into the room conditions for 1h prior to the measurement.	It shall fulfill the specifications in Table 1
Low Temperature	Subject the resonator to $-55^{\circ}\text{C} \pm 2^{\circ}\text{C}$ for 96h, then release the resonator into the room conditions for 1h prior to the measurement.	It shall fulfill the specifications in Table 1
Temperature Cycling	After temperature cycling of blow table was performed 5 times, resonator shall be measured after being placed in natural conditions for 1h. Temp.: $-25 \pm 3^{\circ}\text{C}$, Time: 30 ± 3 min ; Temp.: $85 \pm 3^{\circ}\text{C}$, Time: 30 ± 3 min.	It shall fulfill the specifications in Table 1
Vibration	Subject the resonator to vibration for 2h each in x、 y and z axis With the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10 Hz—55Hz.	It shall fulfill the specifications in Table 1
Mechanical Shock	Drop the resonator randomly onto a wooden floor from the height of 100cm 3 times.	It shall fulfill the specifications in Table 1
Soldering Test	Passed through the re-flow oven under the following condition and left at room temperature for 1h before measurement.	It shall fulfill the specifications in Table 1
Solderability	Dipped in $245^{\circ}\text{C} \pm 5^{\circ}\text{C}$ solder bath for $3\text{s} \pm 0.5\text{s}$ with rosin flux (25wt% ethanol solution.). see <i>Suggested Reflow Profile</i>	The terminals shall be at least 95% covered by solder.
Board Bending	Mount on a glass-epoxy board(width =40mm, thickness=1.6mm),then bend it to 1mm displacement(velocity= 1mm/s) and keep it for 5s.	Mechanical damage such as break shall not occur

Table 1

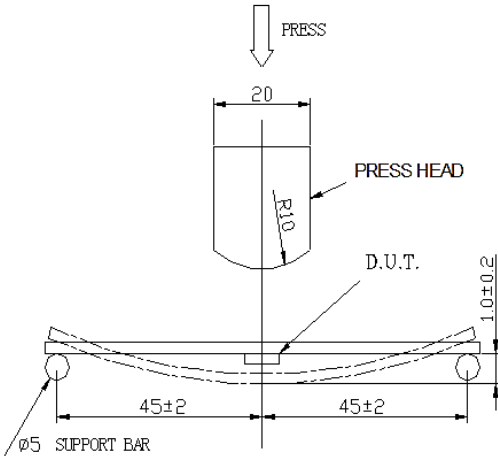
TEST ITEMS	CHARACTERISTICS AFTER TEST	
	VALUE	UNITS
Oscillation Frequency Change $\Delta F_{osc}/F_{osc}$	± 0.3 Max	%
Resonant Impedance ΔR_o	40 Max.	Ω

Note: The limits in the above table are referenced to the initial measurements.

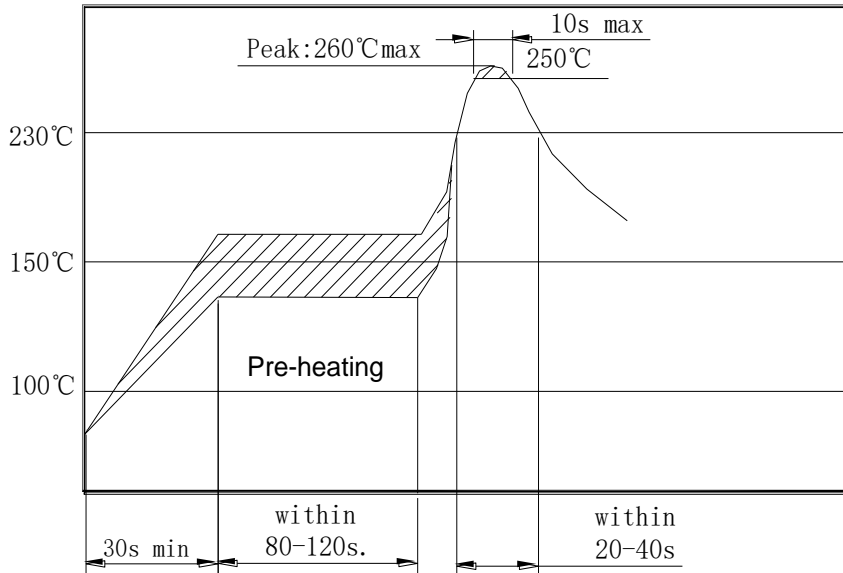
Soldering Test



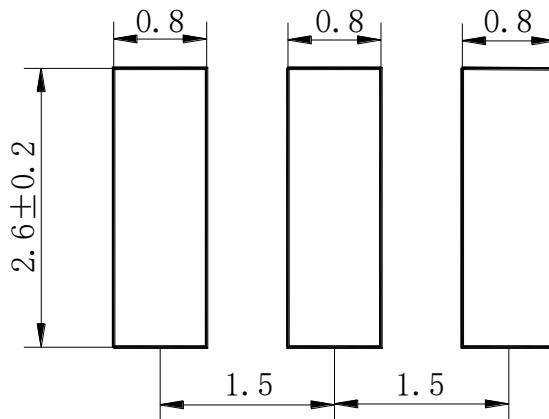
Board Bending



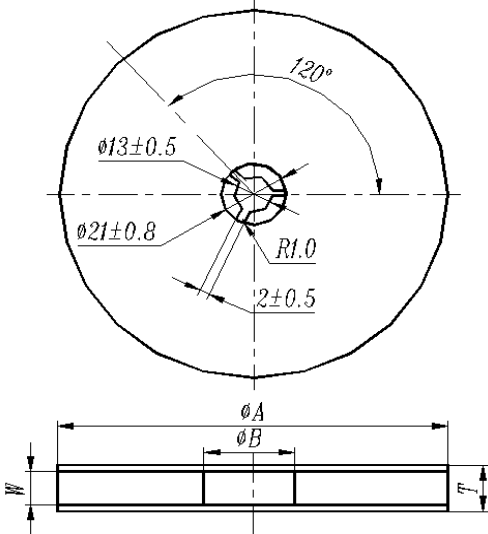
SUGGESTED REFLOW PROFILE (For Reference Only)



RECOMMENDED LAND PATTERN (Unit: mm)

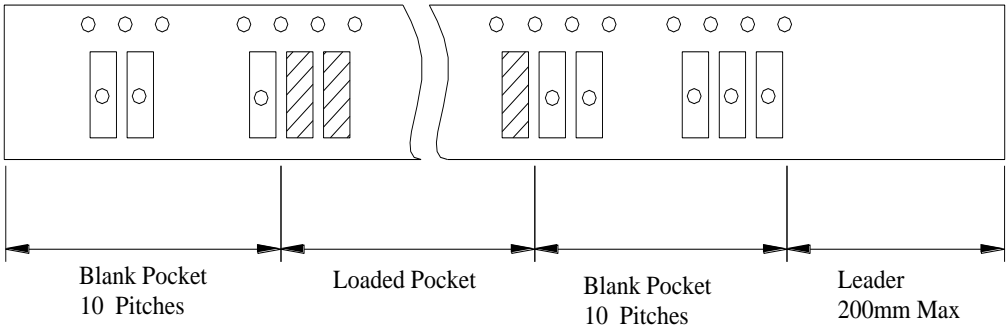


TPAE/REEL DIMENSIONS (Unit: mm)

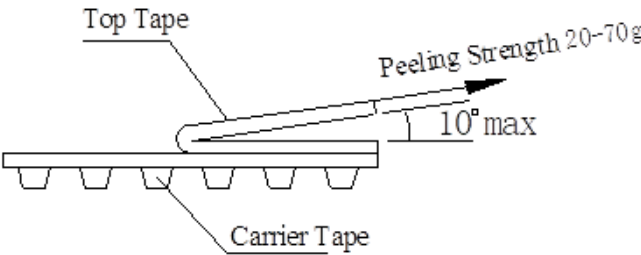


Code	Dimension
φA	180±3.0
φB	60 Min.
W	12.4 Min.
T	19.4 Max.
Qty. Per Reel	3000pcs
Carrier Tape Size	12

PACKING METHOD SKETCH MAP



TEST CONDITION OF PEELING STRENGTH



CAUTION

- Don't apply excess mechanical stress to the component and terminals at soldering. Do not use this product with bend.
- Do not clean or wash the component for it is not hermetically sealed.
- Do not use strong acidity flux, more than 0.2wt% chlorine content, in flow soldering.
- Don't be close to fire.
- This specification mentions the quality of the component as a single unit. Please insure the component is thoroughly evaluated in your application circuit
- Expire date (Shelf life) of the products is 12 months after delivery under the conditions of a sealed and an unopened package. Please use the products within 12 months after delivery. If you store the products for a long time (more than 12 months), use carefully because the products may be degraded in the solder-ability or rusty. Please confirm solder-ability and characteristics for the products regularly.
- Exposure components under soldering condition that is exceeding our recommendation will increase the failure dangerous.
- Please contact us before using the product as automobile electronic component.
- Please return one of these specifications after your signature of acceptance.
- When something gets doubtful with this specifications, we shall jointly work to get an agreement.
- For questions on technology, prices and delivery, please contact our sales offices or e-mail:
sales@NextGenComponent.com .

IMPORTANT NOTES AND DISCLAIMER

1. **ROHS COMPLIANCE:** The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for this product can be obtained at Download Center.
2. **REACH COMPLIANCE:** REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained at Download Center.
3. All Product parametric performance is indicated in the Electrical Characteristics for the listed herein test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
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